

500V N-Channel Enhancement Mode MOSFET

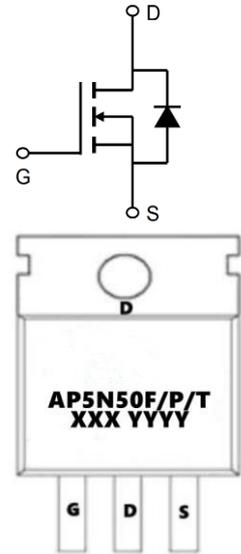
Description

The AP5N50D is silicon N-channel Enhanced VDMOSFETs, is obtained by the self-aligned planar Technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy. The transistor can be used in various power switching circuit for system miniaturization and higher efficiency.

General Features

$V_{DS} = 500V$ $I_D = 5A$

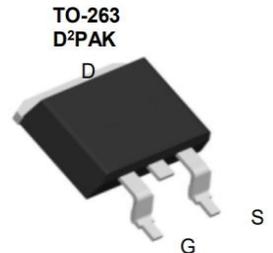
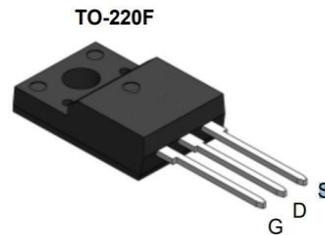
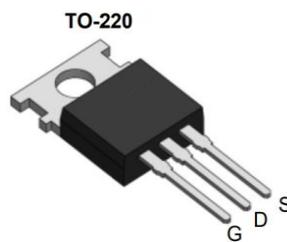
$R_{DS(ON)} < 1.5\Omega @ V_{GS}=10V$ (Type: 1.25Ω)



Application

Uninterruptible Power Supply(UPS)

Power Factor Correction (PFC)



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
AP5N50P	TO-220-3L	AP5N50P XXX YYYY	1000
AP5N50T	TO-263-3L	AP5N50T XXX YYYY	800

Absolute Maximum Ratings ($T_C=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Value	Unit
V_{DSS}	Drain-Source Voltage ($V_{GS} = 0V$)	500	V
I_D	Continuous Drain Current	5	A
I_{DM}	Pulsed Drain Current (note1)	25	A
V_{GS}	Gate-Source Voltage	± 30	V
E_{AS}	Single Pulse Avalanche Energy (note2)	247	mJ
I_{AR}	Avalanche Current (note1)	5	A
E_{AR}	Repetitive Avalanche Energy (note1)	18	mJ
P_D	Power Dissipation ($T_C = 25^\circ C$)	32.9	W
T_J, T_{stg}	Operating Junction and Storage Temperature Range	$-55 \sim +150$	$^\circ C$
R_{thJC}	Thermal Resistance, Junction-to-Case	3.8	$^\circ C/W$
R_{thJA}	Thermal Resistance, Junction-to-Ambient	13.3	$^\circ C/W$



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Electrical Characteristics (T_J=25°C, unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
V(BR)DSS	Drain-Source Breakdown Voltage	V _{GS} = 0V, I _D = 250μA	500	550	--	V
IDSS	Zero Gate Voltage Drain Current	V _{DS} = 650V, V _{GS} = 0V, T _J =25°C	--	--	1	μA
IGSS	Gate-Source Leakage	V _{GS} = ±30V	--	--	±100	nA
VGS(th)	Gate-Source Threshold Voltage	V _{DS} = V _{GS} , I _D = 250μA	2.0	--	4.0	V
RDS(on)	Drain-Source On-Resistance (Note3)	V _{GS} = 10V, I _D = 3.5A	--	1.2	1.5	Ω
C _{iss}	Input Capacitance	V _{GS} = 0V, V _{DS} = 25V, f = 1.0MHz	--	700	--	pF
C _{oss}	Output Capacitance		--	94	--	
C _{rss}	Reverse Transfer Capacitance		--	12	--	
Q _g	Total Gate Charge	V _{DD} =520V, I _D = 7A, V _{GS} = 10V	--	19	--	nC
Q _{gs}	Gate-Source Charge		--	3.7	--	
Q _{gd}	Gate-Drain Charge		--	11	--	
td(on)	Turn-on Delay Time	V _{DD} =325V, I _D = 7A, R _G = 25Ω	--	13	--	ns
t _r	Turn-on Rise Time		--	20	--	
td(off)	Turn-off Delay Time		--	76	--	
t _f	Turn-off Fall Time		--	40	--	
IS	Continuous Body Diode Current	T _C = 25 °C	--	--	7.0	A
ISM	Pulsed Diode Forward Current		--	--	28	A
V _{SD}	Body Diode Voltage	T _J = 25°C, I _{SD} = 7A, V _{GS} = 0V	--	--	1.4	V
trr	Reverse Recovery Time	V _{GS} = 0V, I _s = 7A, di _F /dt = 100A/μs	--	260	--	ns
Q _{rr}	Reverse Recovery Charge		--	3.8	--	μC

Note :

- 1、 The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper.
- 2、 The EAS data shows Max. rating . IAS = 4.5A, VDD = 50V, RG = 25 Ω, Starting T_J = 25 °C
- 3、 The test condition is Pulse Test: Pulse width ≤ 300μs, Duty Cycle ≤ 1%
- 4、 The power dissipation is limited by 150°C junction temperature
- 5、 The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.

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Typical Characteristics

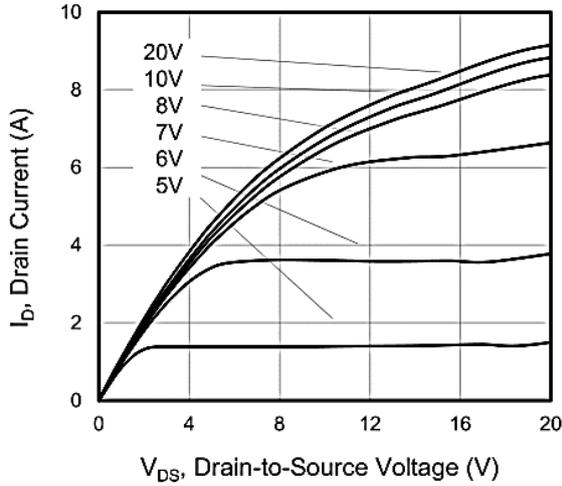


Figure 1. Output Characteristics ($T_J = 25^\circ\text{C}$)

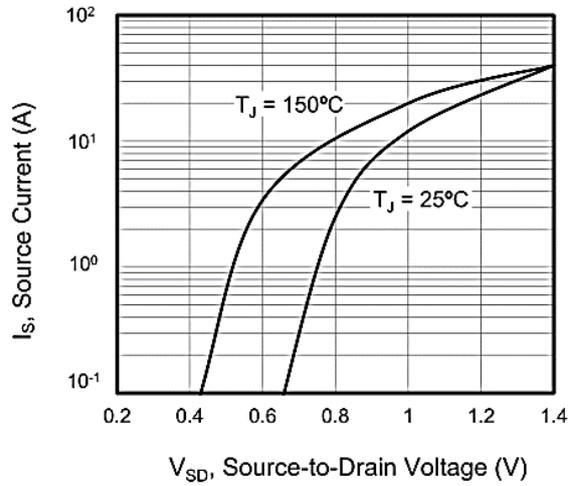


Figure 2. Body Diode Forward Voltage

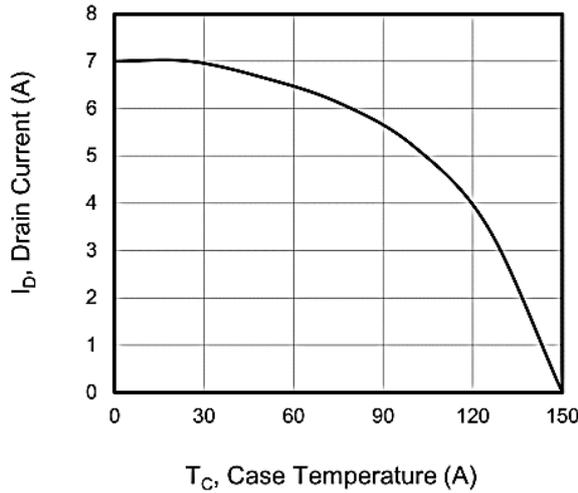


Figure 3. Drain Current vs. Temperature

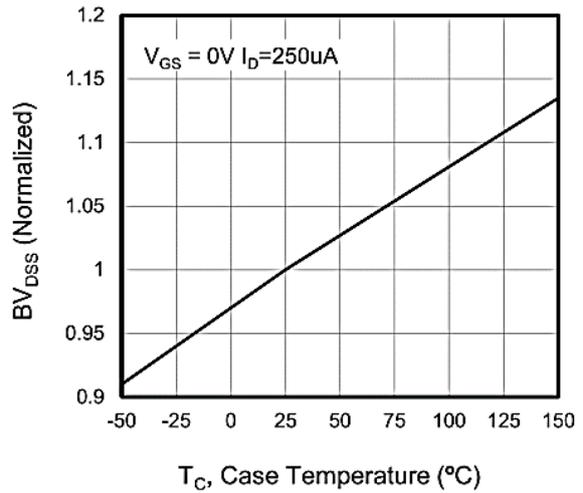


Figure 4. BV_{DSS} Variation vs. Temperature

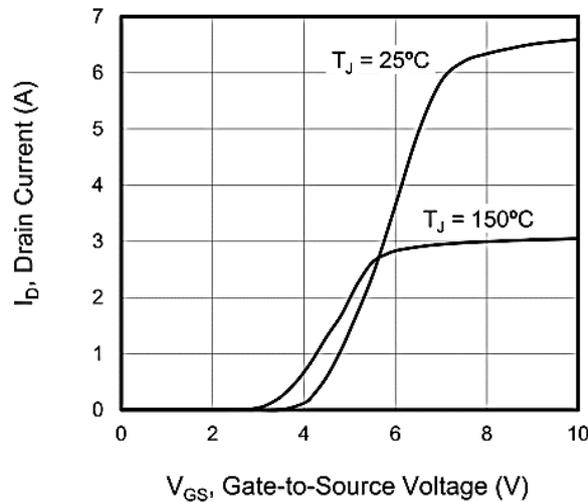


Figure 5. Transfer Characteristics

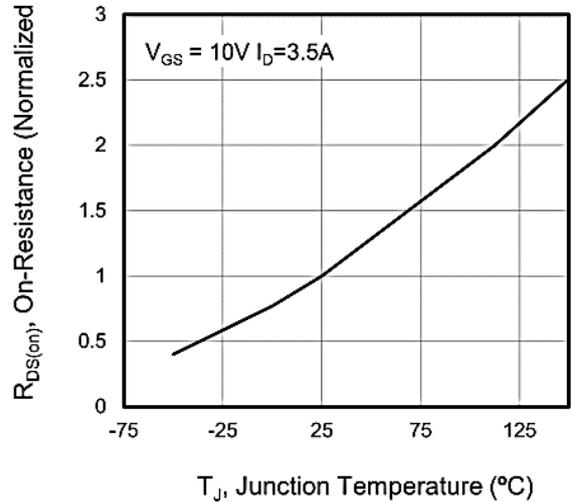


Figure 6. On-Resistance vs. Temperature



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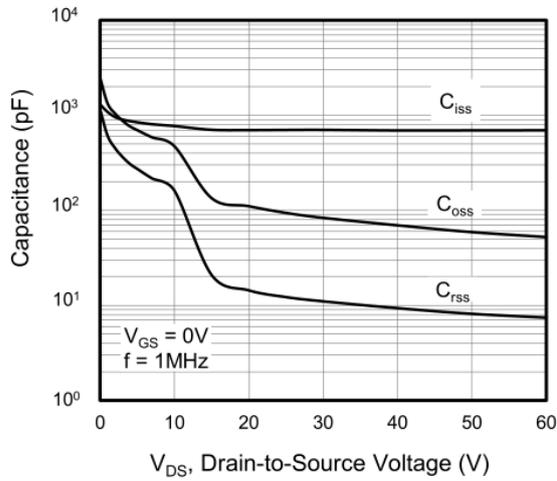


Figure 7. Capacitance

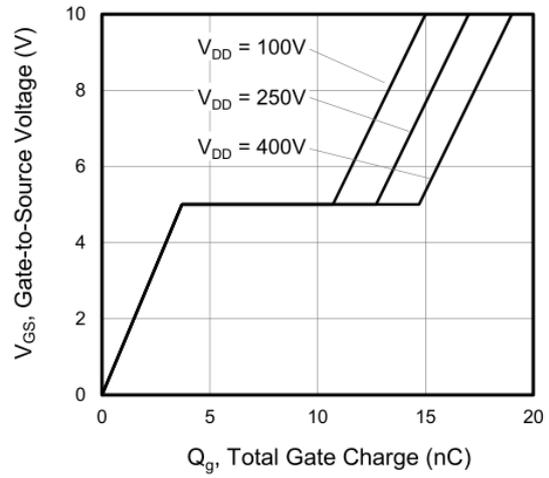


Figure 8. Gate Charge

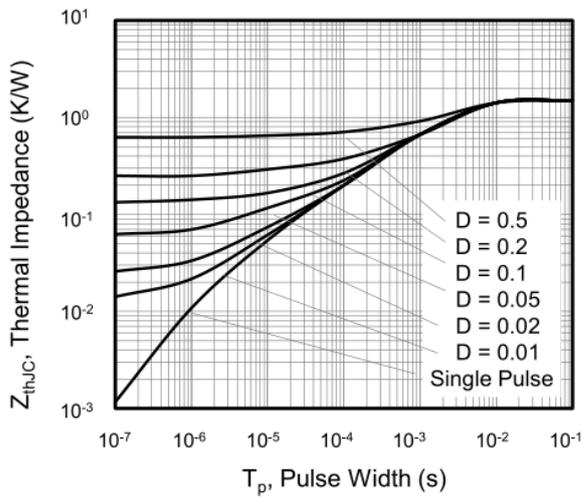
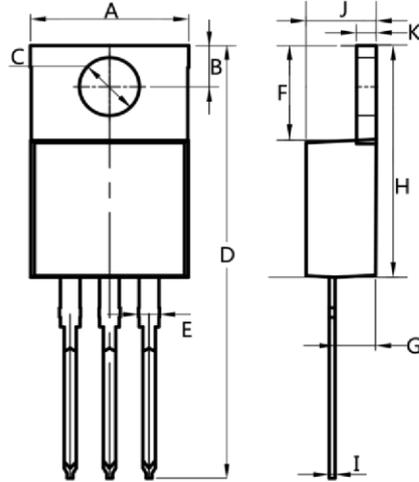
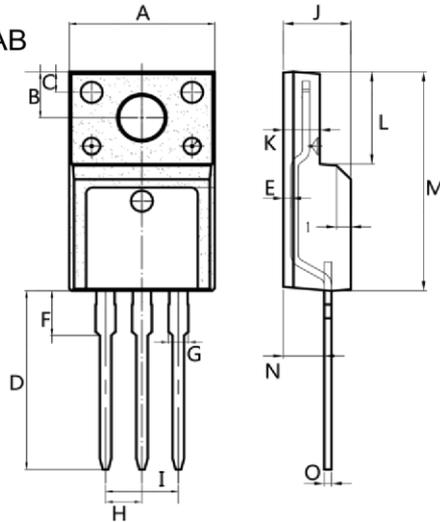


Figure 9. Transient Thermal Impedance

500V N-Channel Enhancement Mode MOSFET
TO-220AB


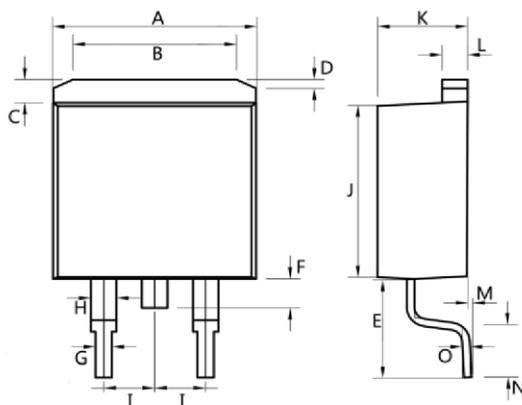
Dim.	Min.	Max.
A	10.0	10.4
B	2.5	3.0
C	3.5	4.0
D	28.0	30.0
E	1.1	1.5
F	6.2	6.6
G	2.9	3.3
H	15.0	16.0
I	0.35	0.45
J	4.3	4.7
K	1.2	1.4

All Dimensions in millimeter

ITO-220AB


Dim.	Min.	Max.
A	9.9	10.3
B	2.9	3.5
C	1.15	1.45
D	12.75	13.25
E	0.55	0.75
F	3.1	3.5
G	1.25	1.45
H	Typ 2.54	
I	Typ 5.08	
J	4.55	4.75
K	2.4	2.7
L	6.35	6.75
M	15.0	16.0
N	2.75	3.15
O	0.45	0.60

All Dimensions in millimeter

TO-263


Dim.	Min.	Max.
A	10.0	10.5
B	7.25	7.75
C	1.3	1.5
D	0.55	0.75
E	5.0	6.0
F	1.4	1.6
G	0.75	0.95
H	1.15	1.35
I	Typ 2.54	
J	8.4	8.6
K	4.4	4.6
L	1.25	1.45
M	0.02	0.1
N	2.4	2.8
O	0.35	0.45

All Dimensions in millimeter